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Buy style.         Chip type         Reliability Indicator:         Established         Reliability Failure Rate Level In Percent:         0.001         Terminal Length:         Between 0.3 millimeters and 0.7 millimeters         Body Widh:         Between 1.8 millimeters and 2.2 millimeters         Body Widh:         Between 1.1 millimeters and 1.5 millimeters         Body Widh:         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         10000 megohms         Capacitance Value Per Section:         10000 megohms         Capacitance Value Per Section:         10000 disfarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Temparture Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0.0 single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -5.00 +5.00 percent single section         -5.00 vers.00 percent single section         -6.00+5.00 percent single section         Ceramic         Insulation Resistance At Reference Temp:         10000.0 megohms	Body Style:
Reliability functors:         Established         Reliability failure Rate Level In Percent:         0.001         Terminal Length:         Between 0.3 millimeters and 0.7 millimeters         Body Length:         Between 1.8 millimeters and 2.2 millimeters         Body With:         Between 1.8 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         10:000 megohms         Caperatine Operating Temp:         10:000 picofarads single section         Nonderated Operating Temp:         10:000 single section         10:000 megohms         10:0000 megohms         Oserment single section         10:0000.0 megohms	
Established         Reliability Failure Rate Level In Percent:         0.001         Terminal Length:         Between 0.3 millimeters and 0.7 millimeters         Body Length:         Between 1.8 millimeters and 2.2 millimeters         Body Width:         Between 1.1 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Destream 5.0 degrees celsius and 12.5 odegrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0.0.4 single section         Nonderated Ontinuous Voltage Rating And Type Per Section:         10.0.0.4 single section         Tolarance Rale Per Section:         10.0.0.4 single section         Case Material:         Case Material:         Case Material:         Case Material:         Dougoms         Dissipation Factor At Reference Tempu:         10000.0 megohms         Dissipation Factor At Reference	
Reliability Failure Rate Level In Percent:         0.001         Forminal Length:         Between 0.3 millimeters and 0.7 millimeters         Body Length:         Between 1.1 millimeters and 2.2 millimeters         Dody Width:         Between 1.1 millimeters and 1.5 millimeters         Dody Height:         1.3 millimeters         Schematic Diagram Designator:         No commo or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Caperatine Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between 5.5.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         10.0.0 dis gingle section         10.0.0 dis gingle section         10.0.0 dis gingle section         10.0.0 dis gingle section         Caramic         10.0.0 dis gingle section         Caramic         10.0.0 dis gingle section         Caramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         10.100         Terminal Surface Treatmen	-
0.001Forminal Length:Between 0.3 millimeters and 0.7 millimetersBody Uength:Between 1.8 millimeters and 2.2 millimetersBody With:Between 1.1 millimeters and 1.5 millimetersPody Height:1.3 millimetersSchematic Diagram Designator:No commo or grounded electrode (s)Insultator Resistance At Maximum Operating Temp:1000.0 megohmsCapacitance Value Per Section:1000.0 picolarads single sectionNo commo or grounded solution of degrees celsiusTempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:0.0 single sectionNonderated Operating Temp:100.0 de single section100.0 de single sectionCapacitance Value Per Section In Ppm Per Deg Celsius:0.0 single section10erance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:0.0 de single sectionCaramic1000.0 groupercent single sectionCapacitance Value Per Section:-3.00+5.00 percent single sectionCaramicInsulation Resistance At Reference Temp:10000.0 megohmsDisplation Factor At Reference Tempurature In Percent:0.150Parimal Surface Treatment:0.161SolderTerminal Surface Treatment:2.150SolderParimal Surface Treatment:2.161SolderSolderParimal Surface Treatment:2.161SolderParimal Surface Treatment:	
Terminal Length:         Between 0.3 millimeters and 0.7 millimeters         Body Length:         Between 1.8 millimeters and 2.2 millimeters         Body Vidth:         Between 1.1 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insultion Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Obj single section         Nonderated Continuous Voltage Rating And Type Per Sections:         100.0 single section         Youds-5.00 percent single section         Nonderated Continuous Voltage Rating And Type Per Sections:         10.0 disingle section         Youds-5.00 percent single section         Postation Resistance At Reference Tempurature In Percent:         Youd	
Between 0.3 millimeters and 0.7 millimeters         Body Length:         Between 1.8 millimeters and 2.2 millimeters         Body Width:         Between 1.1 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Body Height:         1.3 millimeters         Body Height:         1.3 millimeters         Body Edgram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tompurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 dis single section         Nonderated Continuous Voltage Rating And Type Per Section:         -30.0/-30.0 single section         Tolerance Range Per Section:         -30.0/-30.0 single section         Caramic         Eastweria:         Coramic         Insulation Resistance At Reference Temp:         100000.0 megohms         Dispation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:	
Body Length:         Between 1.8 millimeters and 2.2 millimeters         Body Width:         Between 1.1 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between - 55.0 degrees celsius and 125.0 degrees celsius         Capacitance Value Per Section:         10.00 picofarads single section         Nonderated Continuous Voltage Rating And Type Per Section:         10.0.0 ds ingle section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -3.0.0/+3.00 single section         Case Material:         Caramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.160         Dissipation Factor At Reference Tempurature In Percent:         0.160         Terminal Surface Treatment:         Solder         2 bonding pad	-
Between 1.8 millimeters and 2.2 millimeters         Body Width:         Between 1.1 millimeters and 1.5 millimeters         Body Heigh:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         100.0 di single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         Case Material:         Ceramic         Insulation Resistance At Reference Temp:         1000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.450         Terminal Surface Treatment:         Solder         Zerowing Surface Treatment:         Solder         Zerowing Surface Treatment:         Solder         Zerowing Pace	
Body Width:         Between 1.1 millimeters and 1.5 millimeters         Body Heigh:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         10.00 d c single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -3.0.4+3.0.0 single section         -5.00+45.00 percent single section         -5.00+45.00 percent single section         Caramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
Between 1.1 millimeters and 1.5 millimeters         Body Height:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Sections:         10.0.0 de single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         10.0.0 de single section         Tolerance Range Per Section:         -5.00/+5.00 percent single section         Tolerance Range Per Section:         -5.00/+5.00 percent single section         Ceramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Displation Factor At Reference Tempurature In Percent:         0.150         Order         10000.0 megohms         Displation Factor At Reference Tempurature In Percent:         0.150         Oter	
Body Heigh:         1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Monderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Monderated Continuous Voltage Rating And Type Per Section:         100.0 d c single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         0.0.4;30.0 single section         Tolerance Range Per Section:         -5:00/+5:00 percent single section         Caramic         Insulation Resistance At Reference Temp:         100000 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Caramic         Isolder         Partial Surface Treatment:         0.50der         Jober         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.510         Solder         Ierminal Type	-
1.3 millimeters         Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         10.00 d single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         Tolerance Range Per Section:         -30.0/+5.00 percent single section         Case Material:         Caramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
Schematic Diagram Designator:         No common or grounded electrode (s)         Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         10.0 d c single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         7-30.0/+30.0 single section         Case Material:         Ceramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
No common or grounded electrode (s) Insulation Resistance At Maximum Operating Temp: 1000.0 megohms Capacitance Value Per Section: 10.000 picofarads single section Nonderated Operating Temp: Between -55.0 degrees celsius and 125.0 degrees celsius Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius: 0.0 single section Nonderated Continuous Voltage Rating And Type Per Section: 100.0 dc single section Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius: -30.0/+30.0 single section Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius: -30.0/+30.0 single section Case Material: Caramic Insulation Resistance At Reference Temp: 10000.0 megohms Dissipation Factor At Reference Tempurature In Percent: 0.150 Terminal Surface Treatment: Solder Terminal Type And Quantity: 2 bonding pad	
Insulation Resistance At Maximum Operating Temp:         1000.0 megohms         Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         100.0 dc single section         7olerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         7olerance Range Per Section:         -5.00/+5.00 percent single section         Caramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
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Capacitance Value Per Section:         10.000 picofarads single section         Nonderated Operating Temp:         Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         100.0 dc single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         7olerance Range Per Section:         -30.0/+30.0 single section         Capamic         Capamic         -50.0/+5.00 percent single section         Capamic         Insulation Resistance At Reference Temp:         100000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
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Between -55.0 degrees celsius and 125.0 degrees celsius         Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:         0.0 single section         Nonderated Continuous Voltage Rating And Type Per Section:         100.0 dc single section         Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:         -30.0/+30.0 single section         Tolerance Range Per Section:         -5.00/+5.00 percent single section         Case Material:         Ceramic         Insulation Resistance At Reference Temp:         10000.0 megohms         Dissipation Factor At Reference Tempurature In Percent:         0.150         Terminal Surface Treatment:         Solder         Terminal Type And Quantity:         2 bonding pad         Shelf Life:	
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:0.0 single sectionNonderated Continuous Voltage Rating And Type Per Section:100.0 dc single sectionTolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:-30.0/+30.0 single sectionTolerance Range Per Section:-5.00/+5.00 percent single sectionCase Material:CeramicInsulation Resistance At Reference Temp:10000.0 megohmsDissipation Factor At Reference Tempurature In Percent:0.150Terminal Surface Treatment:SolderTerminal Type And Quantity:2 bonding padShelf Life:	
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<ul> <li>-5.00/+5.00 percent single section</li> <li>Case Material:</li> <li>Ceramic</li> <li>Insulation Resistance At Reference Temp:</li> <li>100000.0 megohms</li> <li>Dissipation Factor At Reference Tempurature In Percent:</li> <li>0.150</li> <li>Terminal Surface Treatment:</li> <li>Solder</li> <li>Terminal Type And Quantity:</li> <li>2 bonding pad</li> <li>Shelf Life:</li> </ul>	-
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Terminal Type And Quantity: 2 bonding pad Shelf Life:	
2 bonding pad Shelf Life:	
Shelf Life:	
N/a	
	N/a



Unit Of Measure:

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Demilitarization:

No

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